Taiwan Semiconductor

2A, 200V-1000V Surface Mount Rectifier

FEATURES

- Glass passivated junction chip
- Ideal for automated placement
- Low reverse leakage
- Moisture sensitivity level: level 1, per J-STD-020
- Compliant to RoHS directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21

APPLICATIONS

- Switch Mode Power Supply
- Inverters and Converters
- Free Wheeling diodes

MECHANICAL DATA

- Case: DO-214AC (SMA)
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 1 whisker test
- Polarity: Indicated by cathode band
- Weight: 0.06 g (approximately)

KEY PARAMETERS				
PARAMETER	VALUE	UNIT		
I _F	2	А		
V _{RRM}	200-1000	V		
I _{FSM}	50	А		
T _{J MAX}	150	°C		
Package	DO-214AC (SMA)			





DO-214AC (SMA)



ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted)								
PARAMETER		SYMBOL	S2DA-T	S2GA-T	S2JA-T	S2KA-T	S2MA-T	UNIT
Marking code on the dev	ice		S2DA	S2GA	S2JA	S2KA	S2MA	V
Repetitive peak reverse	voltage	V _{RRM}	200	400	600	800	1000	V
Reverse voltage, total rm	ns value	V _{R(RMS)}	140	280	420	560	700	V
DC blocking voltage		V _{DC}	200	400	600	800	1000	V
Forward current		I _F			2			Α
Surge peak forward current single half sine-	8.3 ms at T _A = 25°C				50			А
wave superimposed on rated load per diode	1.0 ms at T _A = 25°C	IFSM			124			А
Junction temperature		TJ		-	-55 to +15	50		°C
Storage temperature		T _{STG}			-55 to +15	50		°C





THERMAL PERFORMANCE					
PARAMETER	SYMBOL	ТҮР	UNIT		
Junction-to-lead thermal resistance per diode	R _{ejl}	14	°C/W		
Junction-to-ambient thermal resistance per diode	R _{eja}	86	°C/W		
Junction-to-case thermal resistance per diode	R _{eJC}	23	°C/W		

Thermal Performance Note: Units mounted on PCB (5mm x 5mm Cu pad test board)

ELECTRICAL SPECIFICATIONS ($T_A = 25^{\circ}C$ unless otherwise noted)						
PARAMETER	CONDITIONS	SYMBOL	ТҮР	MAX	UNIT	
Forward voltage per diode ⁽¹⁾	$I_F = 1A, T_J = 25^{\circ}C$	V _F	0.90	-	V	
	$I_F = 2A, T_J = 25^{\circ}C$		0.96	1.1	V	
	$I_F = 1A, T_J = 125^{\circ}C$		0.79	-	V	
	$I_F = 2A, T_J = 125^{\circ}C$		0.86	0.97	V	
Reverse current @ rated V_R per diode $^{(2)}$	T _J = 25°C		-	5	μA	
	T _J = 125°C	I _R	-	100	μA	
Junction capacitance per diode	1 MHz, V _R =4.0V	CJ	30	-	pF	

Notes:

(1) Pulse test with PW=0.3 ms

(2) Pulse test with PW=30 ms

ORDERING INFORMATION				
ORDERING CODE	PACKAGE	PACKING		
S2XA-T R3G ⁽¹⁾	SMA	1,800 / 7" Plastic reel		
S2XA-T M2G ⁽¹⁾	SMA	7,500 / 13" Plastic reel		
S2XA-T R2G ⁽¹⁾	SMA	7,500 / 13" Paper reel		

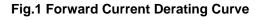
Notes:

(1) "X" defines voltage from 200V(S2DA-T) to 1000V(S2MA-T)



CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$



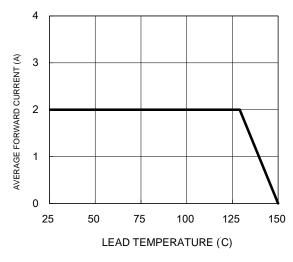
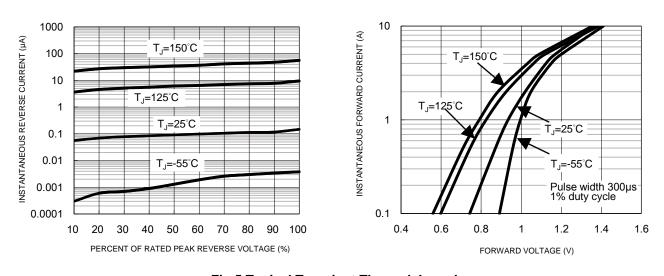


Fig.3 Typical Reverse Characteristics



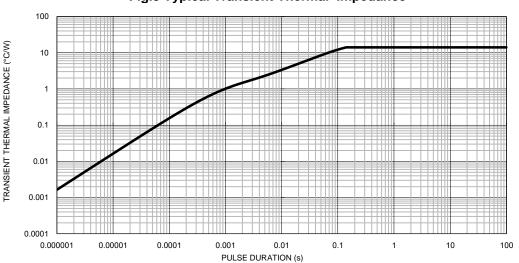


Fig.5 Typical Transient Thermal Impedance

100 CAPACITANCE (pF) 10 f=1.0MHz Vsig=50mVp-p 1 10 1 100

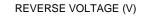


Fig.4 Typical Forward Characteristics

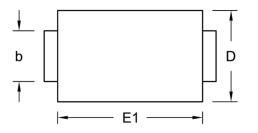
Fig.2 Typical Junction Capacitance

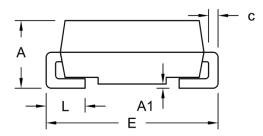
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PACKAGE OUTLINE DIMENSIONS

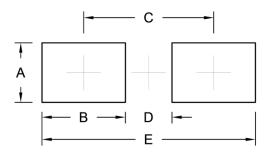
DO-214AC (SMA)





DIM. Uni		(mm)	Unit	(inch)
	Min.	Max.	Min.	Max.
A	1.70	2.30	0.067	0.091
A1	0.05	0.20	0.002	0.008
b	1.20	1.80	0.047	0.071
с	0.15	0.41	0.006	0.016
D	2.40	3.00	0.094	0.118
E	4.80	5.40	0.189	0.213
E1	4.00	4.60	0.157	0.181
L	0.75	1.60	0.030	0.063

SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
A	1.82	0.072
В	2.56	0.101
С	3.99	0.157
D	1.43	0.056
E	6.55	0.258

MARKING DIAGRAM

P/N	
≝ GYW <mark>F</mark>	

P/N G YW F = Marking Code = Green Compound

= Date Code

= Factory Code



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